

TOSHIBA Power Transistor Module Silicon NPN Epitaxial Type (high gain power transistor 4 in 1)

MP4304

High Power Switching Applications.

Hammer Drive, Pulse Motor Drive and Inductive Load Switching.

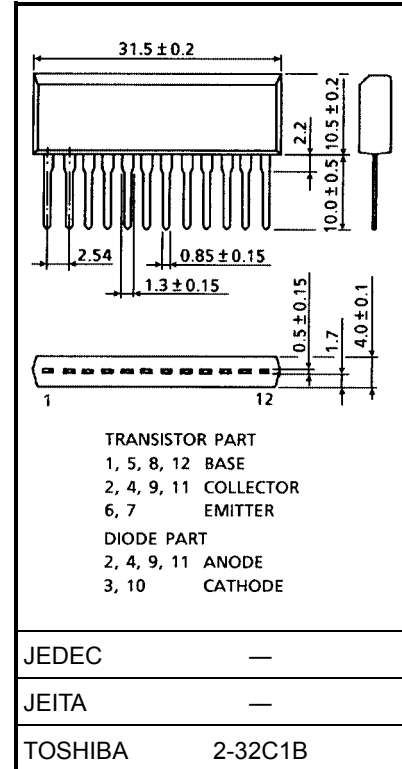
- Small package by full molding (SIP 12 pin)
- High collector power dissipation (4 devices operation)
: $P_T = 4.4 \text{ W}$ ($T_a = 25^\circ\text{C}$)
- High collector current: $I_C \text{ (DC)} = 3 \text{ A}$ (max)
- High DC current gain: $h_{FE} = 600$ (min) ($V_{CE} = 2 \text{ V}$, $I_C = 1 \text{ A}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Rating	Unit
Collector-base voltage		V_{CBO}	80	V
Collector-emitter voltage		V_{CEO}	80	V
Emitter-base voltage		V_{EBO}	7	V
Collector current	DC	I_C	3	A
	Pulse	I_{CP}	5	
Continuous base current		I_B	0.5	A
Collector power dissipation (1 device operation)		P_C	2.2	W
Collector power dissipation (4 devices operation)		P_T	4.4	W
Junction temperature		T_j	150	$^\circ\text{C}$
Storage temperature range		T_{stg}	-55 to 150	$^\circ\text{C}$

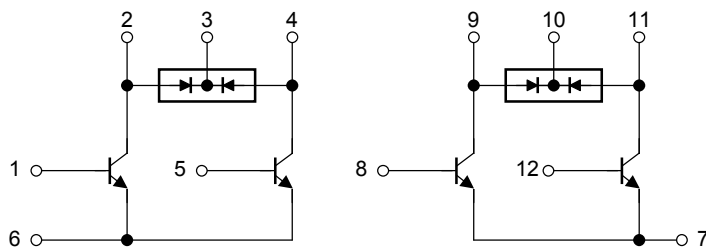
Industrial Applications

Unit: mm



Weight: 3.9 g (typ.)

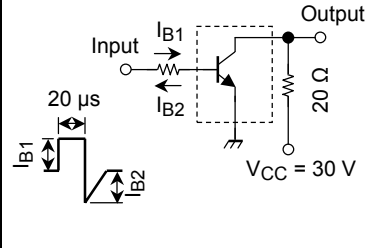
Array Configuration



Thermal Characteristics

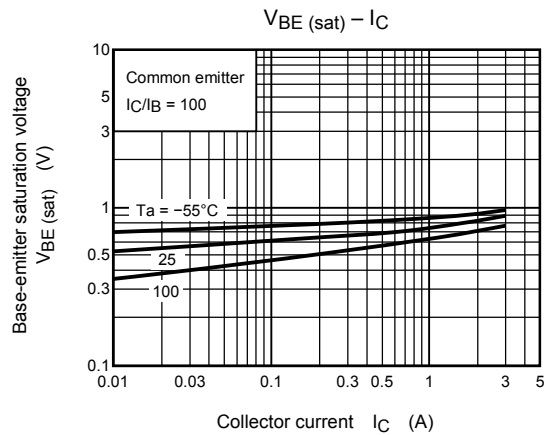
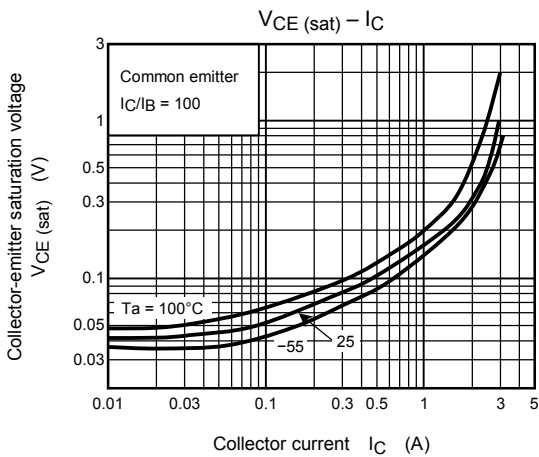
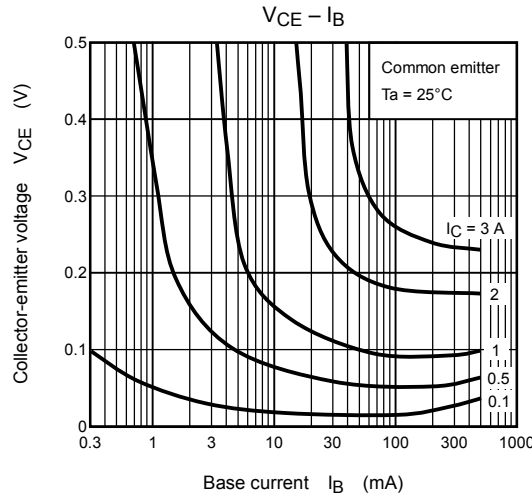
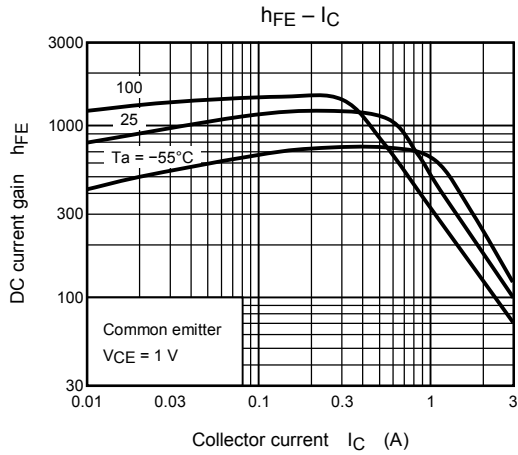
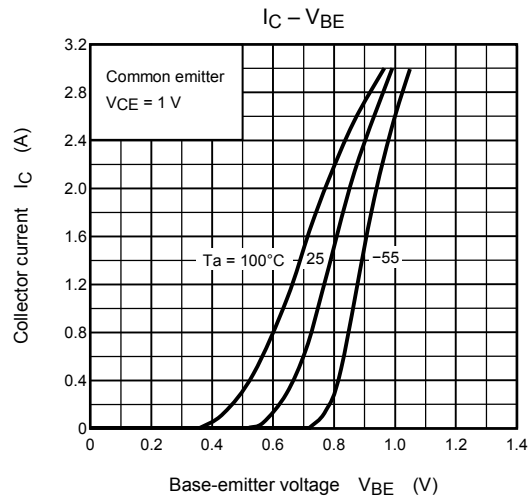
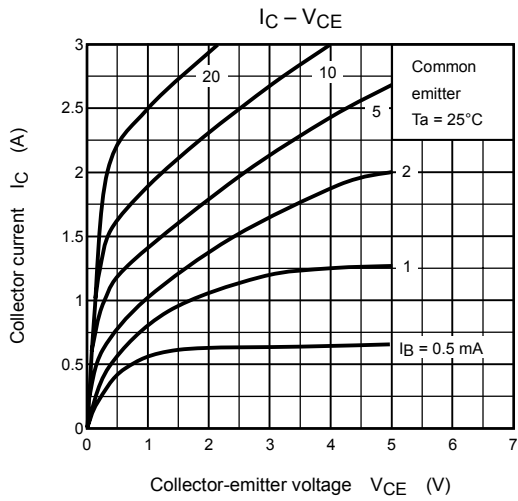
Characteristics	Symbol	Max	Unit
Thermal resistance of junction to ambient (4 devices operation, Ta = 25°C)	$\Sigma R_{th(j-a)}$	28.4	°C/W
Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s)	T _L	260	°C

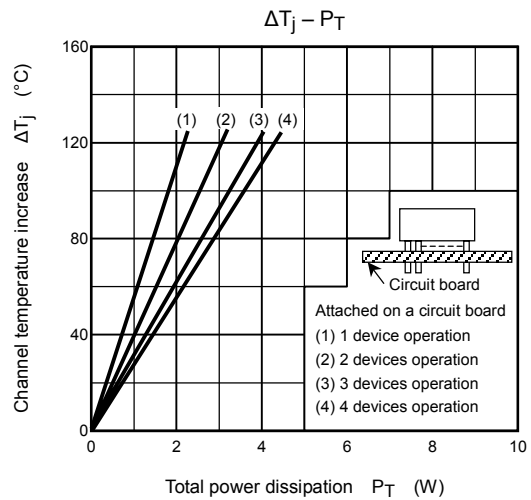
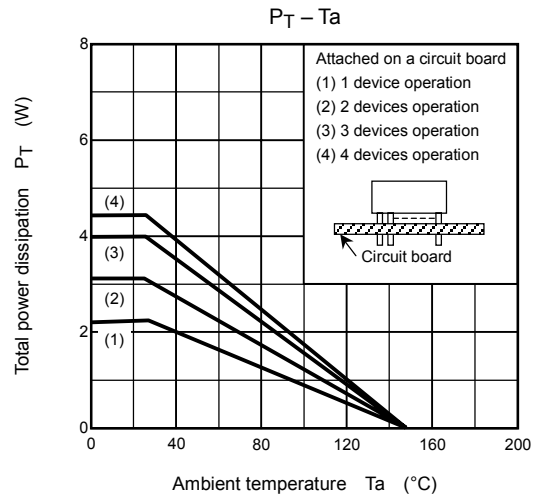
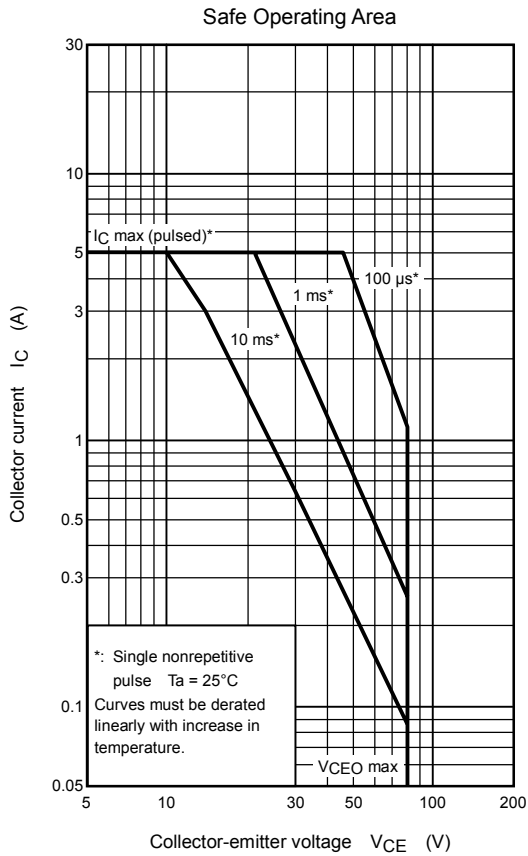
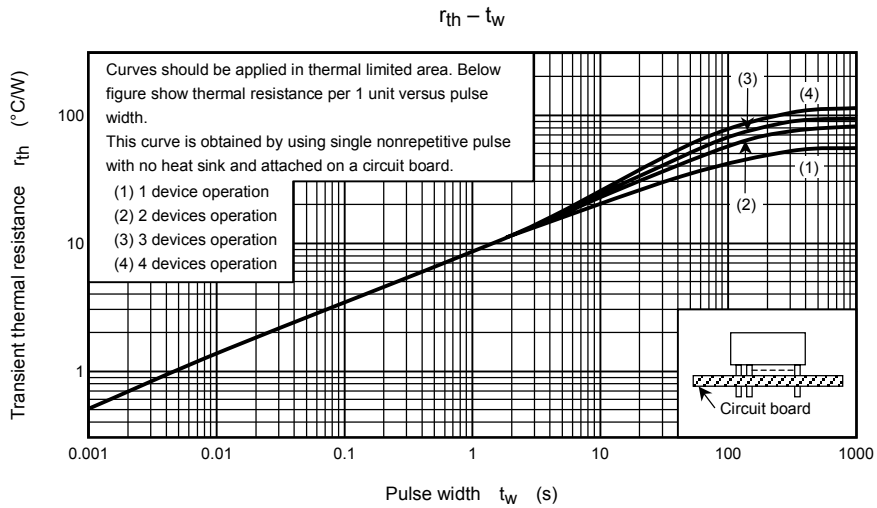
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current		I _{CBO}	V _{CB} = 80 V, I _E = 0 A	—	—	10	μA
Emitter cut-off current		I _{EBO}	V _{EB} = 7 V, I _C = 0 A	—	—	10	μA
Collector-base breakdown voltage		V _{(BR)CBO}	I _C = 1 mA, I _E = 0 A	80	—	—	V
Collector-emitter breakdown voltage		V _{(BR)CEO}	I _C = 10 mA, I _B = 0 A	80	—	—	V
DC current gain		h _{FE} (1)	V _{CE} = 2 V, I _C = 1 A	600	—	—	—
		h _{FE} (2)	V _{CE} = 2 V, I _C = 2 A	150	—	—	
Saturation voltage	Collector-emitter	V _{CE(sat)}	I _C = 1.5 A, I _B = 15 mA	—	0.25	0.5	V
	Base-emitter	V _{BE(sat)}	I _C = 1.5 A, I _B = 15 mA	—	—	1.2	
Transition frequency		f _T	V _{CE} = 2 V, I _C = 0.1 A	—	85	—	MHz
Collector output capacitance		C _{ob}	V _{CB} = 10 V, I _E = 0 A, f = 1 MHz	—	50	—	pF
Switching time	Turn-on time	t _{on}	 <p style="text-align: center;">I_{B1} = -I_{B2} = 15 mA, duty cycle ≤ 1%</p>	—	0.4	—	μs
	Storage time	t _{stg}		—	2.6	—	
	Fall time	t _f		—	1.3	—	

Flyback-Diode Rating and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Maximum forward current	I _{FM}	—	—	—	3	A
Reverse current	I _R	V _R = 80 V	—	—	0.4	μA
Reverse voltage	V _R	I _R = 100 μA	80	—	—	V
Forward voltage	V _F	I _F = 1 A	—	—	1.5	V





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